

(2.00 mm) .0787"

PROFILE SMT HEADER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?TMM

Insulator Material:

Black Liquid Crystal Polymer Terminal Material:

Phosphor Bronze Plating:

Sn or Au over 50μ" (1.27 μm) Ni Current Rating: 3.2 A per pin

(1 pin powered per row) Operating Temp Range:
-55°C to +105°C with Tin;
-55°C to +125°C with Gold

Voltage Rating: 500 VAC mated with SQW 450 VAC mated with SQT **RoHS Compliant:**

Processing: Lead-Free Solderable:

SMT Lead Coplanarity: (0.15 mm) .006" max

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality





ALSO AVAILABLE (MOQ Required)

· Other platings Contact Samtec.

Mates with:

CLT, SQT, SQW, ESQT, TLE, SMM, MMS, TCSD

OTHER SOLUTIONS

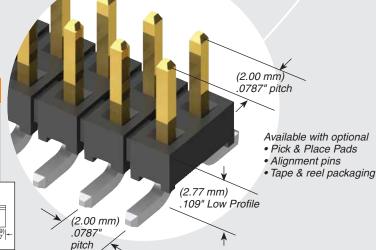
Through-Hole



2 mm Shunt

Specify 2SN-BK-G shunt with Gold plating.





ROW

OPTION



No. of positions x (2.00) .0787

回

(3.94)`.155[°]

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LEAD

STYLE

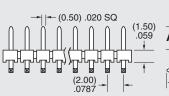


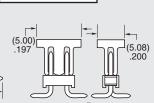
PLATING

OPTION

− F = Gold flash on post, Matte Tin on tail − L = 10µ" (0.25 µm) Gold on post, Matte Tin on tail	= Sing Rov — [= Dou Rov
−S = 30µ" (0.76 µm) Gold on post, Matte Tin on tail −T = Matte Tin	

EAD STYLE	Α	MATES WITH	
-01	(3.20) .126	SQT, SQW, ESQT, TLE, SMM, MMS, TCSD	
-04	(1.91) .075	CLT	
-05	(1.65) .065		
-06	(4.27) .168	CLT-BE	





= Alignment Pin (Metal or plastic at Samtec's discretion) (5 positions minimum) (-D only)

SM

OTHER

OPTION



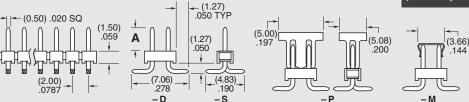
(Specify position of omitted pin) -M

= Metal Pick & Place Pad (4 positions minimum) (-T plating not available) (-D only)

= Pick & Place Pad (3 positions minimum)

–TR

=Tape & Reel Packaging (3 thru 36 positions only)



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Note:

Some lengths, styles and

options are non-standard, non-returnable.